II-V COMPOUND SEMICONDUCTOR FILM AND GROWTHETHOD, GAN SYSTEM SEMICONDUCTOR FILM AND ITS FORMATION, GAN SYSTEM SEMICONDUCTOR STACKED STRUCTURE AND ITS FORMATION, AND GAN SYSTEM SEMICONDUCTOR ELEMENT AND ITS **MANUFACTURE** (ID

Patent Number:

JP10312971

Publication date:

1998-11-24

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Requested Patent:

☐ JP10312971

Application Number: JP19980062760 19980313

Priority Number(s):

IPC Classification:

H01L21/205; C30B29/40; H01L33/00

EC Classification:

Equivalents:

JP3139445B2

Abstract

PROBLEM TO BE SOLVED: To suppress the introduction of defects by suppressing cracks generated by difference in the thermal expansion coefficients between a growing III-V comp. semiconductor layer and a substrate crystal, and a difference in grid constants.

SOLUTION: Through the use of a substrate limiting a growing region 13 by a mask 14, the facet structure of a III-V comp. semiconductor film 15 is formed (b) by epitaxial growth, for growing (c) the facet structure to cover the mask 14. In addition, the facet structure is completely embedded (d). A III-V comp. semiconductor layer with a flat surface is finally formed (e).

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